

## Material Data Sheet for Nitride-Bonded Silicon Carbide

### 1. Material

FCT Denotation	SC-N
Material Description	Nitride-Bonded Silicon Carbide ("NSiC")

### 2. General Properties

Chemical Composition	SiC (wt.-%)	70 - 75
	Si <sub>3</sub> N <sub>4</sub> (wt.-%)	25 - 30

Bulk Density	$\rho$	[1]	(g/cm <sup>3</sup> )	2.77 - 2.82
Residual Porosity			(%)	10 - 12
Open Porosity			(%)	10 - 12
Grain Size (Longitudinal Direction)			( $\mu\text{m}$ )	1 - 150

### 3. Mechanical Properties

Hardness		[2]	(GPa)	-
Compressive Strength			(MPa)	600 - 700
Bendig Strength	$\sigma$	[3]	(MPa)	180
Weibull-Modulus	$m$			20
Fracture Toughness	$K_{Ic}$	[4]	(MPa <sup>1/2</sup> )	(3.0 - 3.2)
Youngs Modulus	$E$		(GPa)	240
Poisson Ratio	$\nu$			0.2

### 4. Thermal Properties

Max. Working Temperature				
- Inert Atmosphere			(°C)	1500
- Air			(°C)	1500
Thermal Conductivity	$\lambda$ (20°C)		(W/mK)	23
Coeff. of Thermal Expansion	$\alpha$ (-1000°C)		(10 <sup>-6</sup> K <sup>-1</sup> )	4.0
Thermal Shock Parameter	$R_1$	[5]	(K)	150
Thermal Shock Parameter	$R_2$	[6]	(W/m)	3450

### 5. Specific Properties

- [1] Determination of density and porosity according to DIN 623-2
- [2] Average value of 4-point bending strength at room temperature according to DIN EN 843-1
- [3] Hardness according to DIN EN 843-4
- [4] Calculated from crack length derived from Vickers hardness indentation, according to Niihara  $R_1 = \frac{\sigma(1-\nu)}{E\alpha}$
- [5] Critical temperature difference for an infinite high heat transfer (quenching)
- [6] Thermal shock coefficient at finite constant heat transfer (slowly heating)  $R_2 = \frac{\sigma(1-\nu)}{E\alpha} \lambda$

The material characteristics listed above are measured at testing samples. They cannot be transferred to components with different size, shape or surface properties. We reserve the right to alter properties within the scope of technical progress or new developments.